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Part Number: [0432028816](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Shielded, No Panel Grounding Tabs, without Bottom Grounding Tab, Front Position PCB Ground Tab, 8/8

Documents:
[3D Model](#) [Product Specification PS-43202-001 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
UL E107635

General

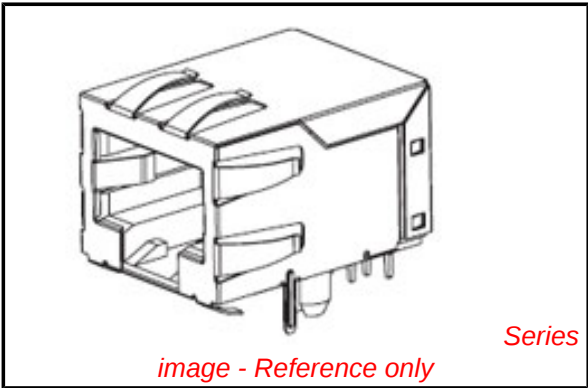
Product Family Modular Jacks/Plugs
Series [43202](#)
Component Type PCB Jack
Magnetic No
Overview [modular_plugs_jacks](#)
Performance Category 3
Power over Ethernet (PoE) N/A
Product Name RJ45

Physical

Color - Resin Black
Durability (mating cycles max) 500
Flammability 94V-0
Inverted / Top Latch No
Lightpipes/LEDs None
Material - Metal Brass, Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin High Temperature Thermoplastic
Orientation Right Angle (Side Entry)
PCB Retention Yes
PCB Thickness Recommended (in) 0.062 In
PCB Thickness Recommended (mm) 1.60 mm
Packaging Type Tray
Panel Mount With Flange
Pitch - Mating Interface (in) 0.050 In
Pitch - Mating Interface (mm) 1.27 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25
Plating min: Termination (µin) 100
Plating min: Termination (µm) 2.5
Ports 1
Positions / Loaded Contacts 8/8
Surface Mount Compatible (SMC) Yes
Temperature Range - Operating -40°C to +85°C
Termination Interface: Style Through Hole
Wire/Cable Type N/A

Electrical

Current - Maximum per Contact 1.5A
Grounding to PCB Yes



EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Halogen-Free
Status
Not Halogen-Free

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[43202Series](#)

Mates With
FCC 68 Plugs

Grounding to Panel	None
Shielded	Yes
Voltage - Maximum	125V

Solder Process Data

Duration at Max. Process Temperature (seconds)	5
Lead-free Process Capability	Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Packaging Specification	PK-43202-004
Product Specification	PS-43202-001, RPS-43202-002
Sales Drawing	SDA-43202

This document was generated on 06/07/2010

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NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
TERMINALS: PHOSPHOR BRONZE, .012/ 0.30 THICK
SHIELD: BRASS, .007/ 0.18 THICK

2) FINISH:

TERMINALS:

A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS AND/OR SHIELD.

SHIELD:

100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES / 1.27
MICROMETERS COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43202.

4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-003.
UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
PER MOLEX PACKAGING SPECIFICATION PK-43202-005.
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-004.

5) SEE SHEETS 7 - 9 FOR P.C. BOARD LAYOUTS.

6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.

7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



SHIELDED MODULAR JACK
SHOWN WITH PANEL GROUND
OPTION 'D' AND FRONT
PCB GROUND TABS.

DRAWING LEGEND

SHEET 1- NOTES, DRAWING LEGEND
SHEET 2- SHIELDED MODULAR JACK W/ BOTTOM GROUND TABS
SHEET 3- SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS
SHEET 4- UNSHIELDED MODULAR JACK
SHEET 5- PART NUMBER CHARTS
SHEET 6- PART NUMBER CHARTS
SHEET 7- FOOTPRINT LAYOUT FOR 4 POSITION HOUSING
SHEET 8- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING
SHEET 9- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING

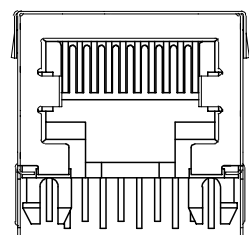
OBS COLORED JACKS EC NO: UCP2008-1189 DRAWN:JBELL 2007/11/30 CHKD:LSCHMIDT 2008/02/20 APPR:FSM/TH 2008/03/04	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION	
					mm	INCH	DRAWN BY JTR	DATE 1993/03/31	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED		
				4 PLACES	± ---	± ---	CHECKED BY	DATE 1993/03/31			
				3 PLACES	± ---	± .010	JTR	DATE 1993/03/31			
				2 PLACES	± 0.25	± .014	APPROVED BY	DATE 1993/03/31			
				1 PLACE	± 0.36	± ---	RAS	DATE 1993/03/31			
				ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHTS 5&6		SDA-43202		1 OF 9	
						THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

9	L2
8	L2
7	L2
6	L4
5	L
4	K2
3	L1
2	L1
1	L4
SH	REV

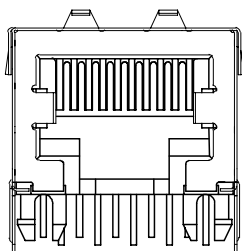
SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS

SIZE 8, LOADED 10 VERSION SHOWN

SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



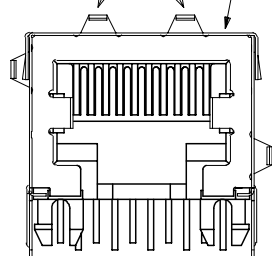
OPTION "E"
NO TOP OR SIDE TABS



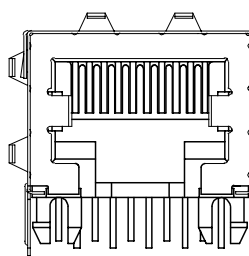
OPTION "F"
TOP TABS

OPTIONAL TOP GROUND TABS

SHIELDED MODULAR JACK ASSEMBLY
SEE SHEET 6 FOR MATERIAL NO.

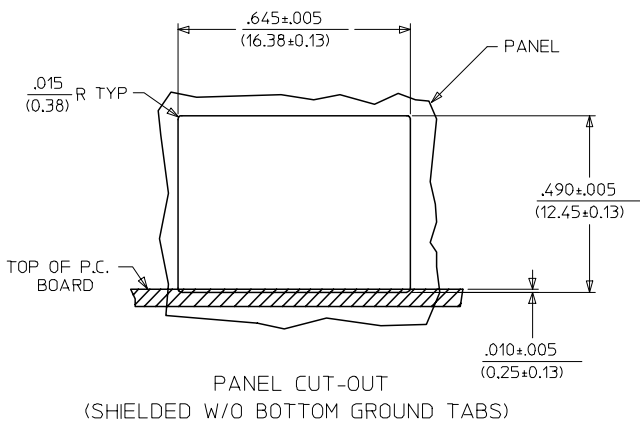


OPTION "G"
TOP AND STAGGERED SIDE TABS

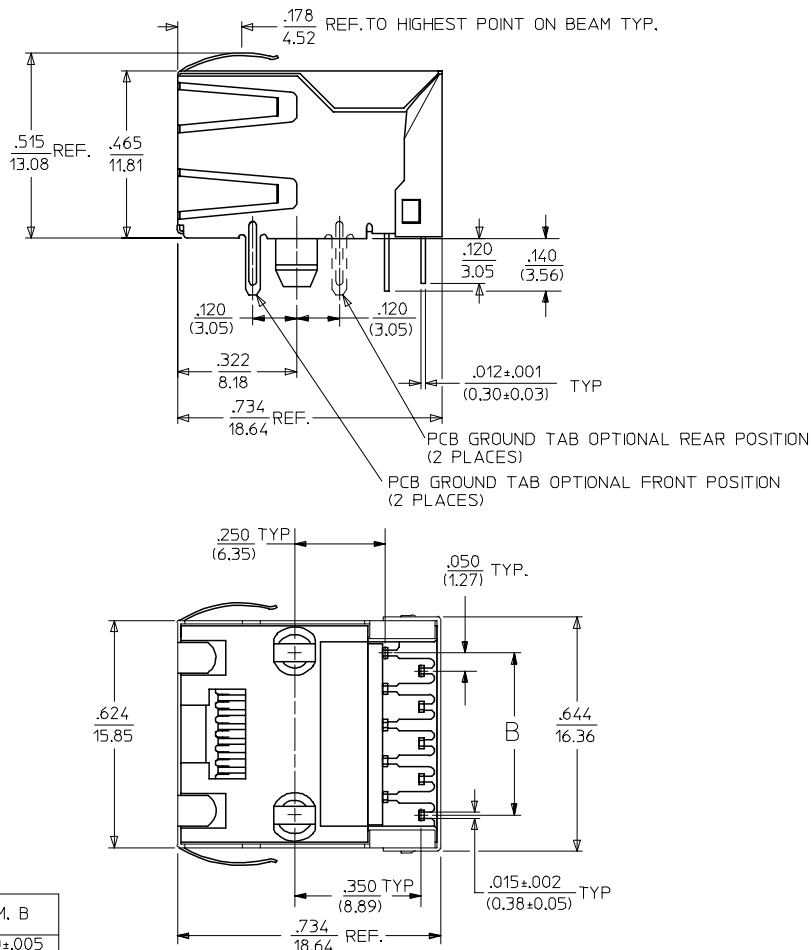


OPTION "H"
TOP AND SIDE TABS

OPTIONAL SIDE
GROUND TABS
(2 PLACES)

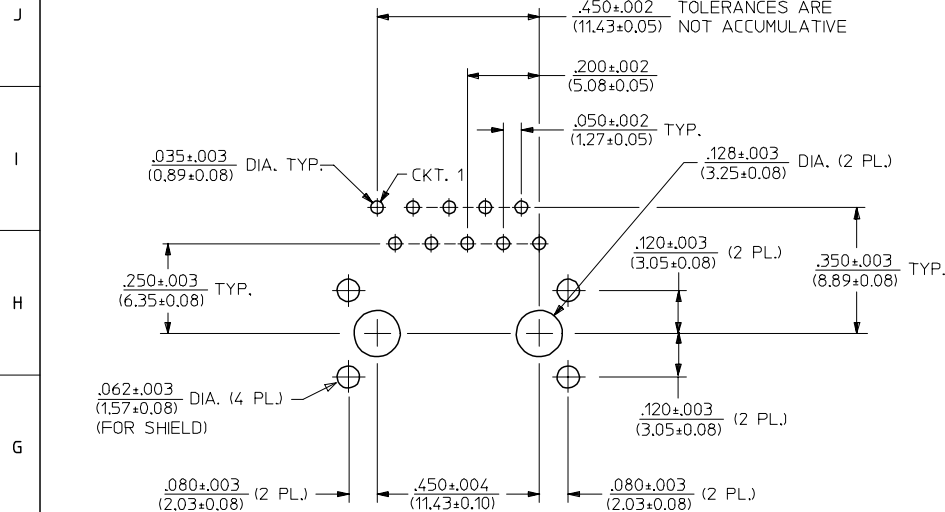


HOUSING SIZE	CIRCUIT SIZE	DIM. B
8	10	.450±.005 (11.43±0.13)
8	8	.350±.005 (8.89±0.13)

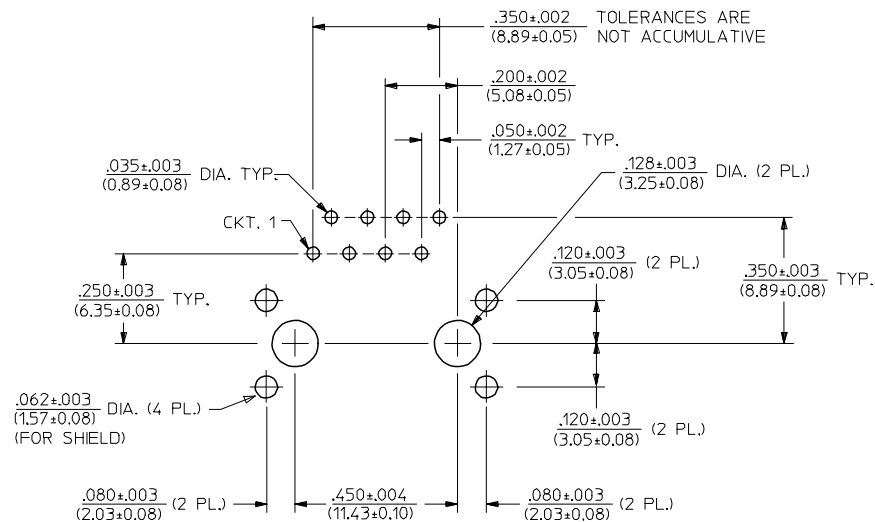


SEE SHEET ONE EC NO: UCP2004-1888 DRAWN: SCHMIDT 2004/03/31 CHKD: SCHMIDT 2004/03/31 APPR: FSMITH 2004/03/31 L1	DESCRIPTION	QUALITY SYMBOLS	 -0	GENERAL TOLERANCES (UNLESS SPECIFIED)			SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION	REVISE ON CAD ONLY				
							DIMENSION STYLE			TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY				
							IN/MM							
							DRAWN BY						DATE	
							JTR						1993/03/31	
							CHECKED BY			DATE				
							JTR			1993/03/31				
							APPROVED BY			DATE				
							RAS			1993/03/31				
							MATERIAL NO.			DOCUMENT NO.		SHEET NO.		
			SEE SHT 6		SDA-43202		3 OF 9							
			DRAFT WHERE APPLICABLE			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								
			MUST REMAIN WITHIN DIMENSIONS											

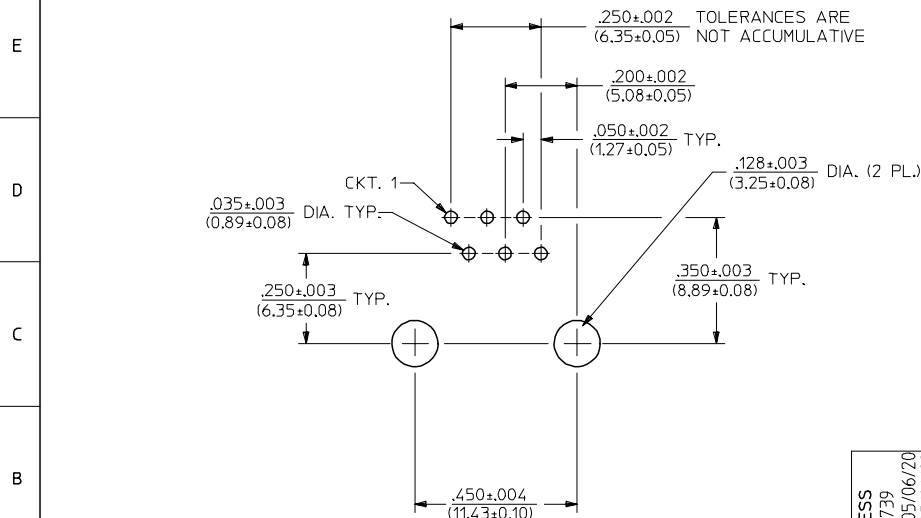
	13	12	11	10	9	8	7	6	5	4	3	2	1			
J	SHIELDED MODULAR JACKS W/O BOTTOM GROUND TABS (SHEET 3)							UNSHIELDED MODULAR JACKS- (SHEET 4)							J	
	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION	TERMINAL PLATING OPTION	PACKAGING	HOUSING COLOR	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION	KEYING OPTION	PACKAGING OPTION	HOUSING COLOR	
	43202-8800	8	10	E	FRONT POSITION	A	TRAY	BLACK	43202-4101	4	4	A	NO	TRAY	BLACK	
	43202-8801	8	10	F	FRONT POSITION	A	TRAY		43202-4104	4	2	A	NO	TRAY		
I	43202-8802	8	10	G	FRONT POSITION	A	TRAY		43202-6101	6	6	A	NO	TRAY		I
	43202-8803	8	10	H	FRONT POSITION	A	TRAY		43202-6102	6	6	B	NO	TRAY		
	43202-8808	8	10	E	REAR POSITION	A	TRAY		43202-6104	6	4	A	NO	TRAY		
	43202-8809	8	10	F	REAR POSITION	A	TRAY		43202-6105	6	4	B	NO	TRAY		
	43202-8810	8	10	G	REAR POSITION	A	TRAY		43202-6107	6	2	A	NO	TRAY		
	43202-8811	8	10	H	REAR POSITION	A	TRAY		43202-6110	6	6	B	NO	TUBE		
H	43202-8816	8	8	E	FRONT POSITION	A	TRAY		43202-8101	8	10	A	NO	TRAY		H
	43202-8817	8	8	F	FRONT POSITION	A	TRAY		43202-8104	8	8	A	NO	TRAY		
	43202-8818	8	8	G	FRONT POSITION	A	TRAY		43202-8105	8	8	B	NO	TRAY		
	43202-8819	8	8	H	FRONT POSITION	A	TRAY		43202-8113	8	8	A	YES	TRAY		
	43202-8824	8	8	E	REAR POSITION	A	TRAY		43202-8116	8	6	A	NO	TRAY		
	43202-8825	8	8	F	REAR POSITION	A	TRAY		43202-8119	8	4	A	NO	TRAY		
	43202-8826	8	8	G	REAR POSITION	A	TRAY		43202-8122	8	2	A	NO	TRAY		
G	43202-8827	8	8	H	REAR POSITION	A	TRAY		43202-8504	8	8	A	NO	TUBE		G
								43202-8513	8	8	A	YES	TUBE			
F															F	
E															E	
D															D	
C															C	
B															B	
A															A	



PC BOARD LAYOUT FOR 8 POSITION HOUSING
(10 CIRCUIT FOOTPRINT SHOWN)
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR 8 POSITION HOUSING
(8 CIRCUIT FOOTPRINT SHOWN)
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR 8 POSITION HOUSING
(6 CIRCUIT FOOTPRINT SHOWN)
(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

ADD PCB THICKNESS EC NO: UCP2005-2739 DRWN:LSCHMIDT 2005/06/20 CHKD:ELHAG 2005/06/22 APPR:FSMTH 2005/06/23	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION		REVISE ON CAD ONLY				
			mm		INCH	DIMENSION STYLE IN/MM		TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY						
			4 PLACES	± ---	± ---	DRAWN BY L.E.LENZ	DATE 1995/03/09							
			3 PLACES	± ---	± .010	CHECKED BY JTR	DATE 1995/03/09	MOLEX MOLEX INCORPORATED						
			2 PLACES	± 0.25	± .014	APPROVED BY RAS	DATE 1995/03/09			MATERIAL NO. SEE SHTS 5&6	DOCUMENT NO. SDA-43202	SHEET NO. 9 OF 9		
			1 PLACE	± 0.36	± ---	DRAFT WHERE APPLICABLE								
			ANGULAR ±1/2°											
			MUST REMAIN WITHIN DIMENSIONS						THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

ADD PCB THICKNESS
EC NO: UCP2005-2739
DRAWN: SCHMIDT 2005/06/20
CHKD: ELHAG 2005/06/22
APPR: FSMITH 2005/06/23
REV L2

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: org@lifeelectronics.ru

www.lifeelectronics.ru